

EE 330

Lecture 16

Devices in Semiconductor Processes

- Capacitors
- MOSFETs

Use of Piecewise Models for Nonlinear Devices when Analyzing Electronic Circuits

Process:

1. Guess state of the device
2. Analyze circuit
3. Verify State
4. Repeat steps 1 to 3 if verification fails
5. Verify model (if necessary)

Observations:

- Analysis generally simplified dramatically (particularly if piecewise model is linear)
- Approach applicable to wide variety of nonlinear devices
- Closed-form solutions give insight into performance of circuit
- Usually much faster than solving the nonlinear circuit directly
- Wrong guesses in the state of the device do not compromise solution (verification will fail)
- Helps to guess right the first time
- Detailed model is often not necessary with most nonlinear devices
- Particularly useful if piecewise model is PWL (but not necessary)
- For practical circuits, the simplified approach usually applies

Key Concept For Analyzing Circuits with Nonlinear Devices

Basic Devices and Device Models

- Resistor

- Diode

-  Capacitor

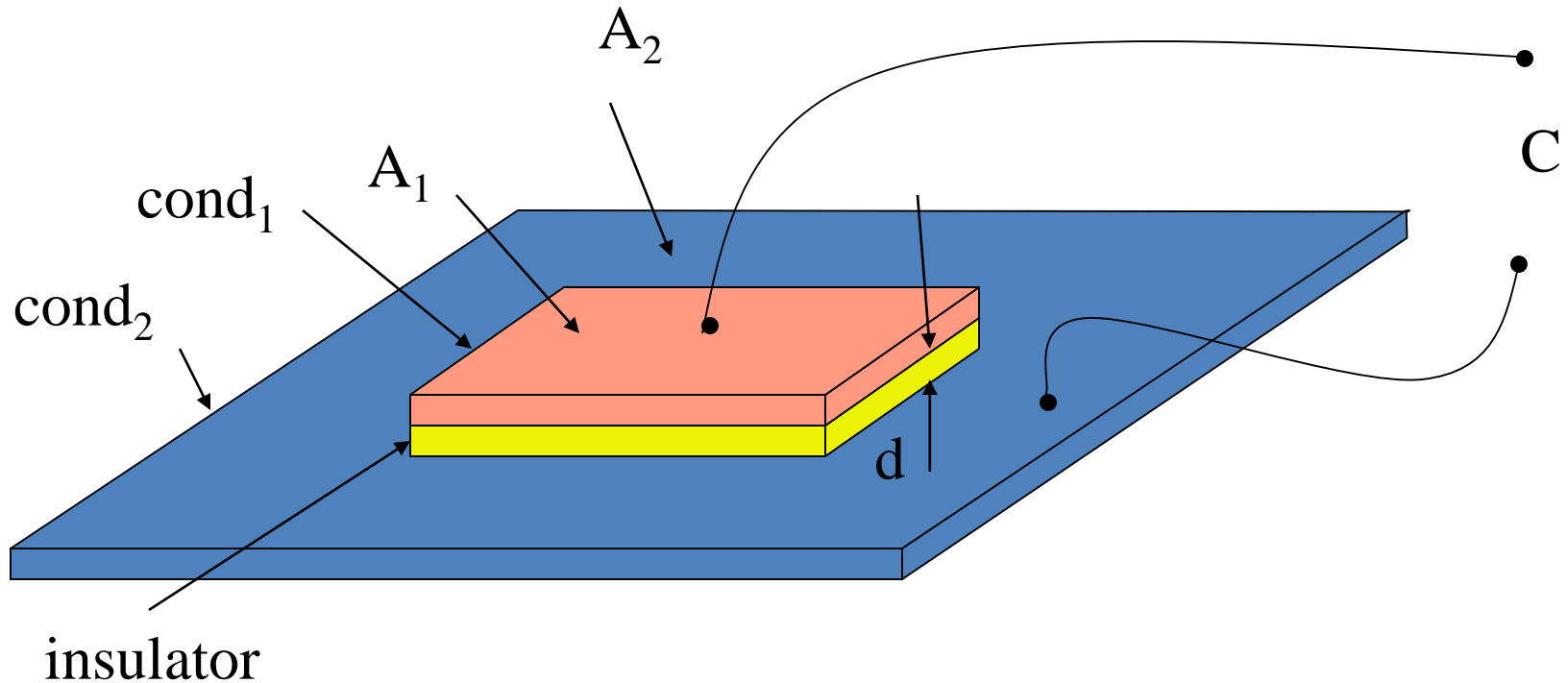
- MOSFET

- BJT

Capacitors

- Types
 - Parallel Plate
 - Fringe
 - Junction

Parallel Plate Capacitors



A = area of intersection of A_1 & A_2

One (top) plate **intentionally** sized smaller to determine C

$$C = \frac{\epsilon A}{d}$$

Parallel Plate Capacitors

$$\text{If } C_d = \frac{\text{Cap}}{\text{unit area}}$$

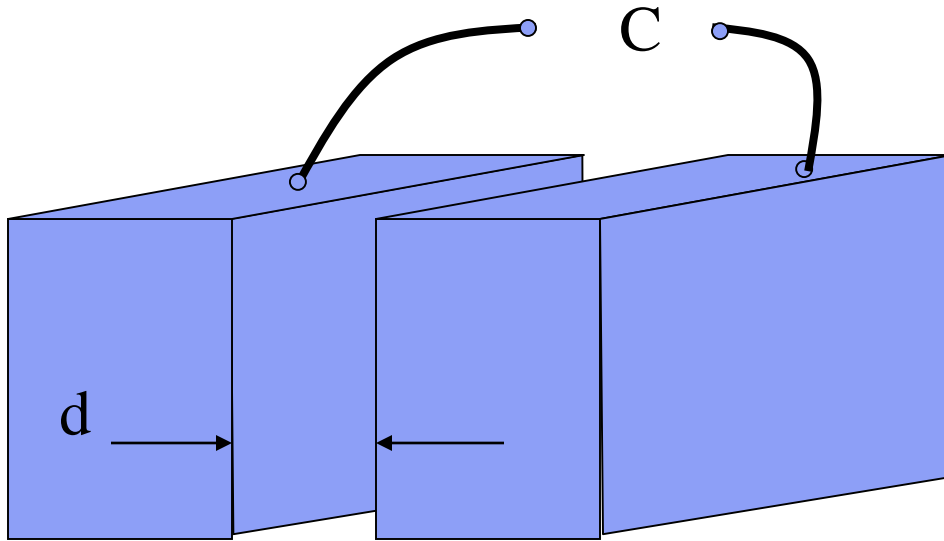
$$C = \frac{\epsilon A}{d}$$

$$C = C_d A$$

where

$$C_d = \frac{\epsilon}{d}$$

Fringe Capacitors

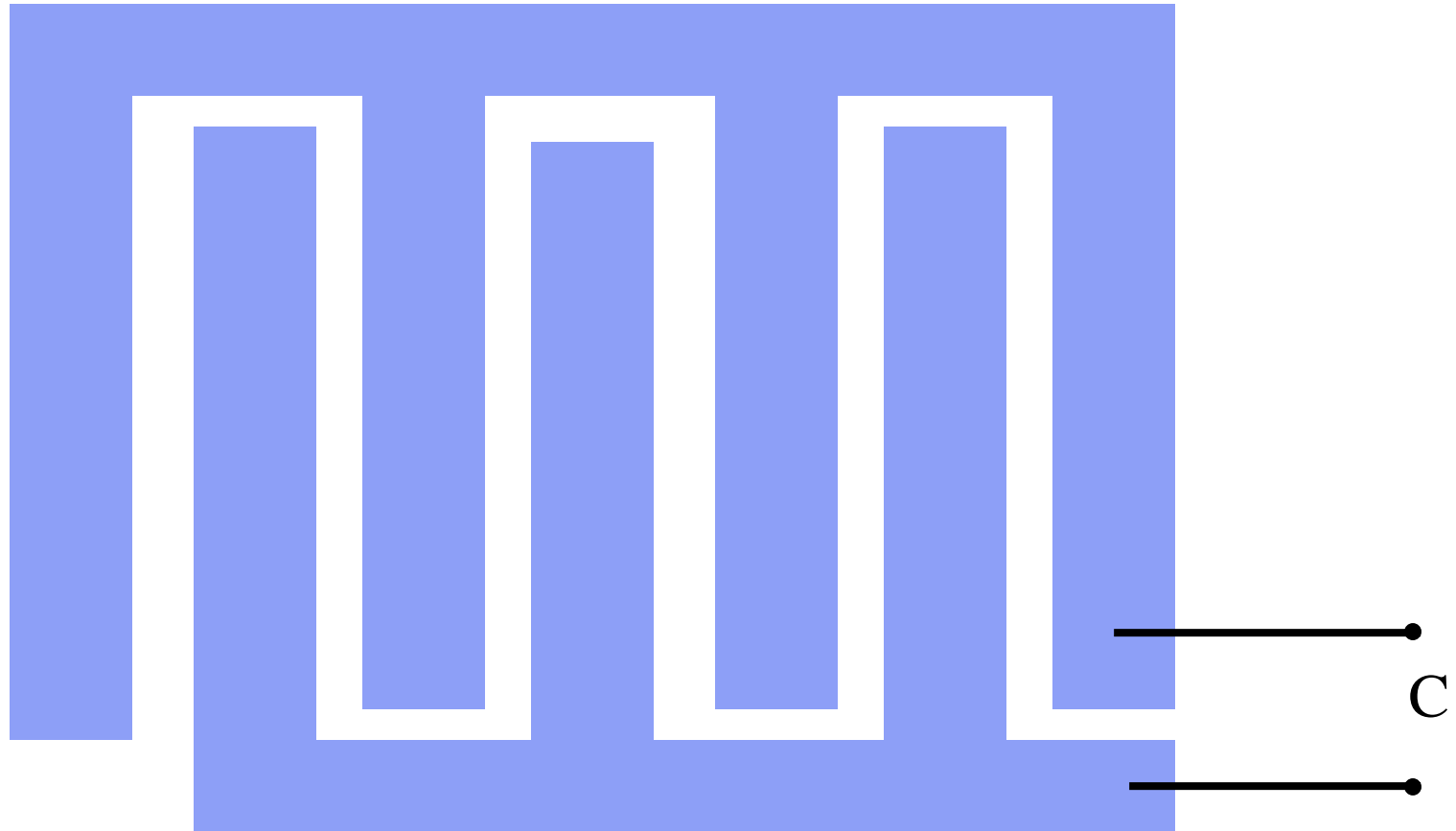


$$C = \frac{\epsilon A}{d}$$

A is the area where the two plates are parallel

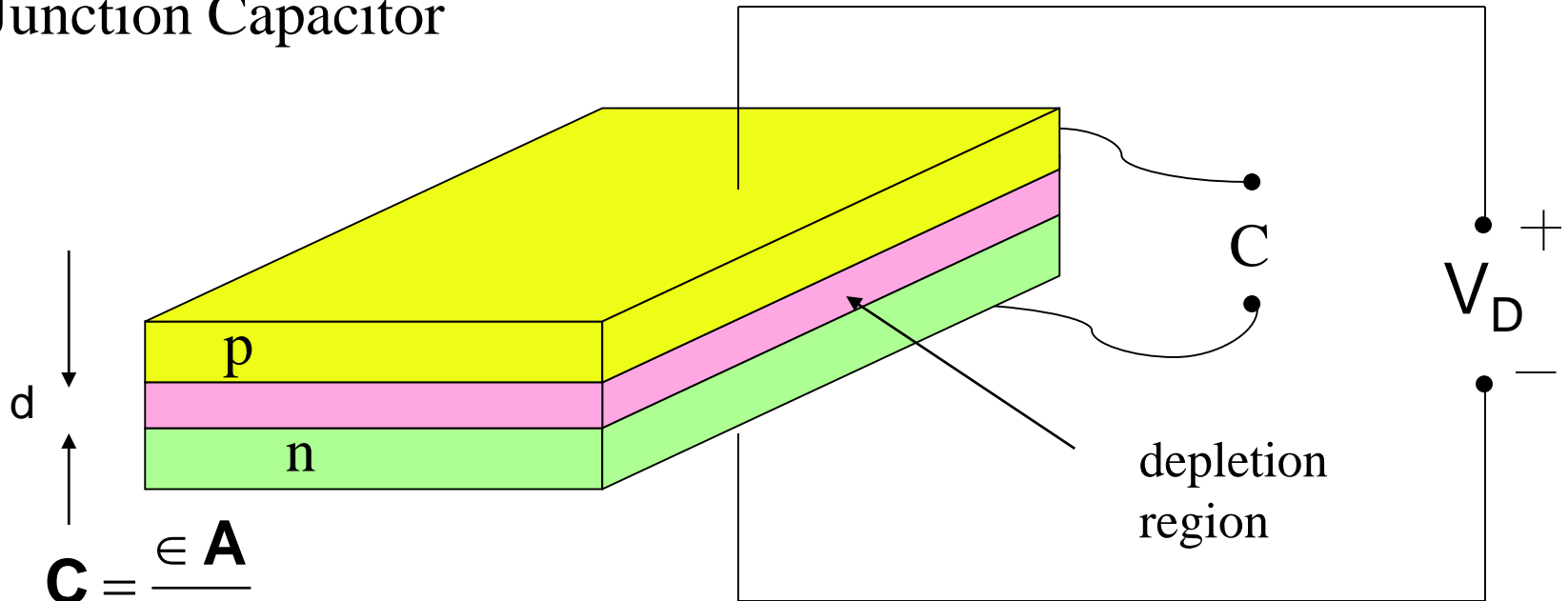
Only a single layer is needed to make fringe capacitors

Fringe Capacitors



Capacitance

Junction Capacitor



$$C = \frac{\epsilon A}{d}$$

ϵ is dielectric constant

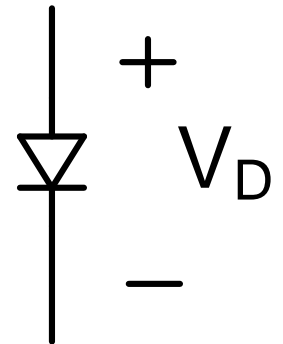
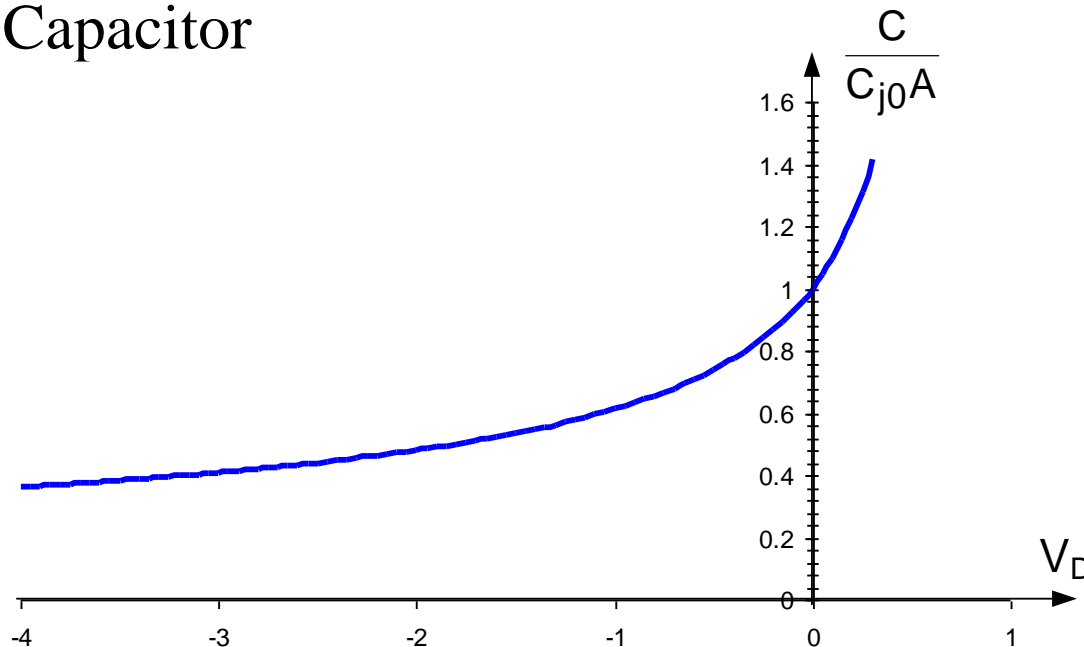
$$C = \frac{C_{j0} A}{\left(1 - \frac{V_D}{\phi_B}\right)^n} \quad \text{for } V_{FB} < \frac{\phi_B}{2}$$

$$\phi_B \cong 0.6V \quad n \cong 0.5$$

Note: d is voltage dependent
 -capacitance is voltage dependent
 -usually parasitic caps
 -varicaps or varactor diodes exploit voltage dep. of C

Capacitance

Junction Capacitor



$$C = \frac{C_{j0}A}{\left(1 - \frac{V_D}{\phi_B}\right)^n} \quad \text{for } V_{FB} < \frac{\phi_B}{2}$$

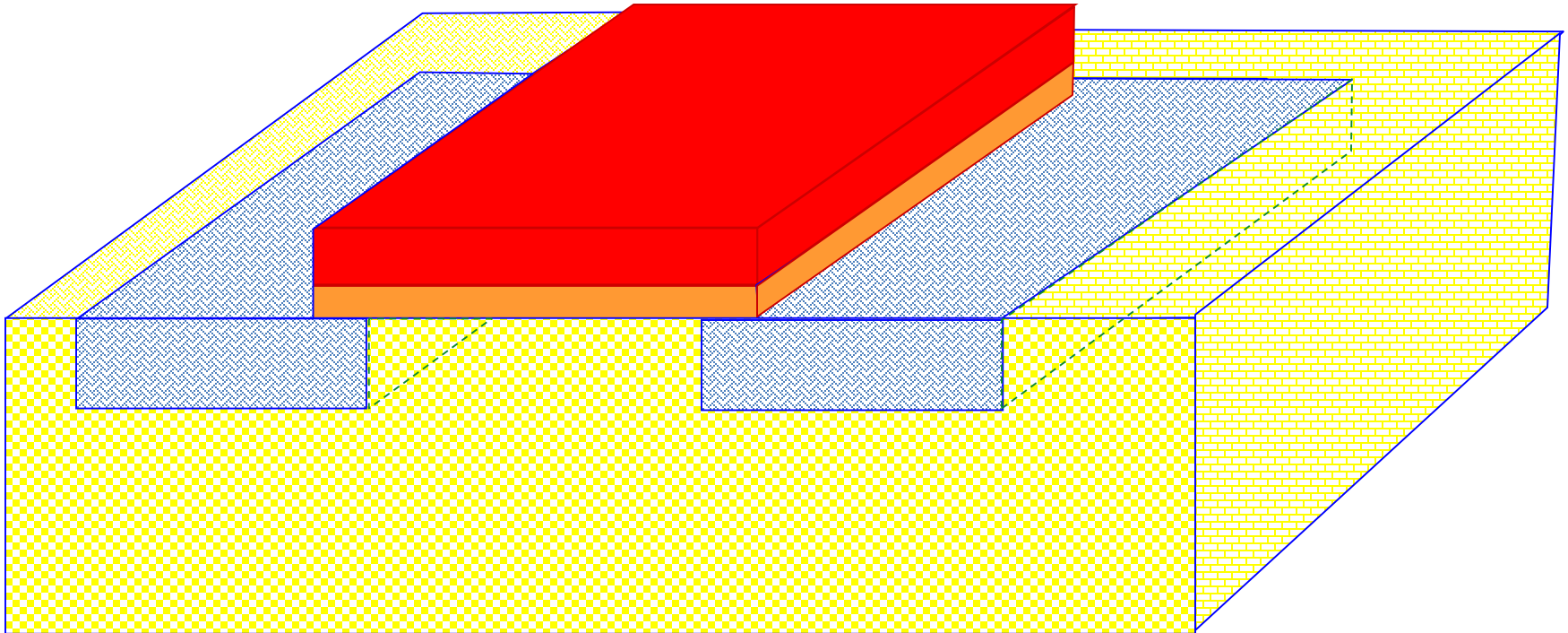
Voltage dependence is substantial

$$\phi_B \cong 0.6V \quad n \cong 0.5$$

Basic Devices and Device Models

- Resistor
- Diode
- Capacitor
- MOSFET
- BJT

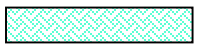
n-Channel MOSFET



Poly



Gate oxide

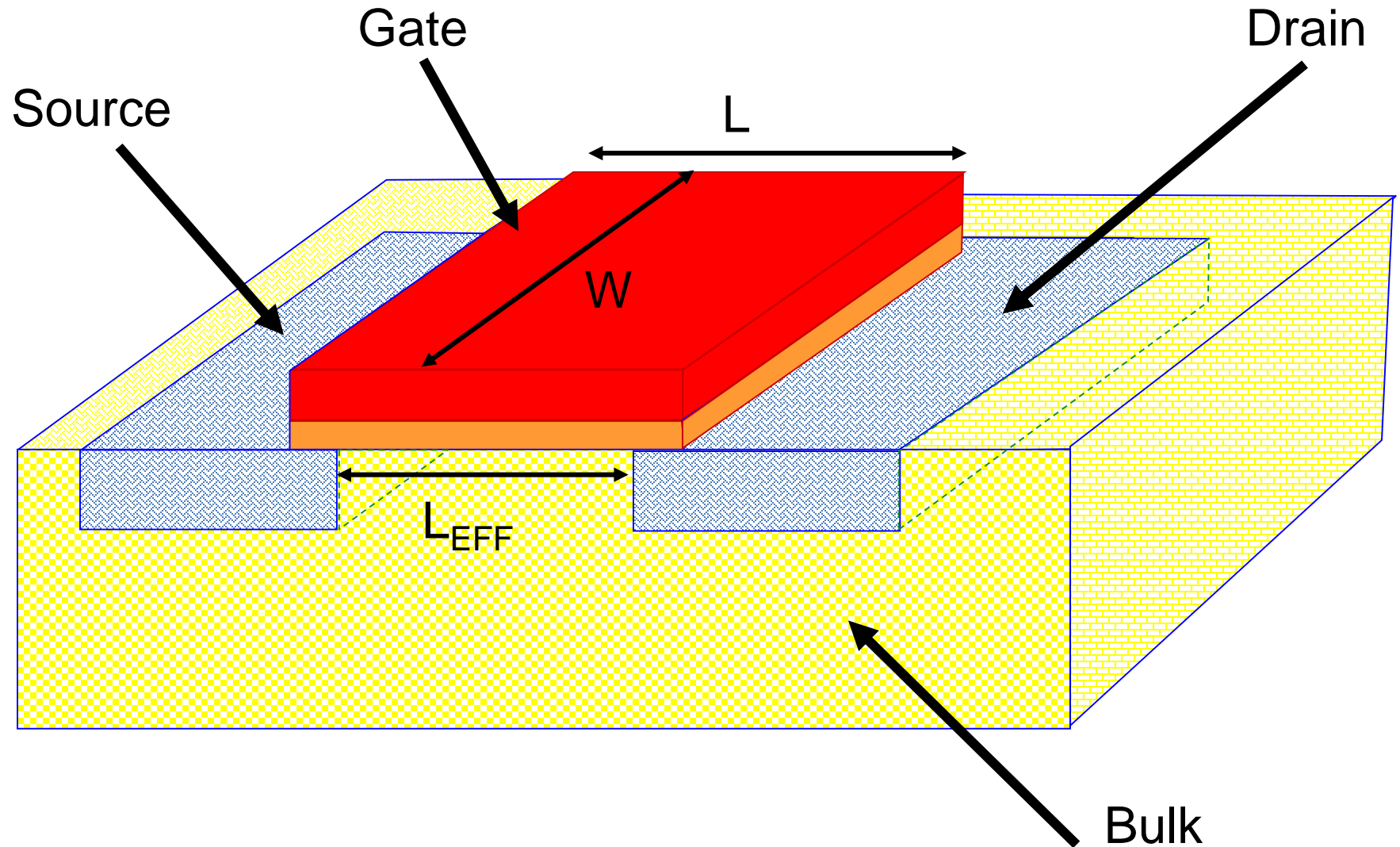


n-active

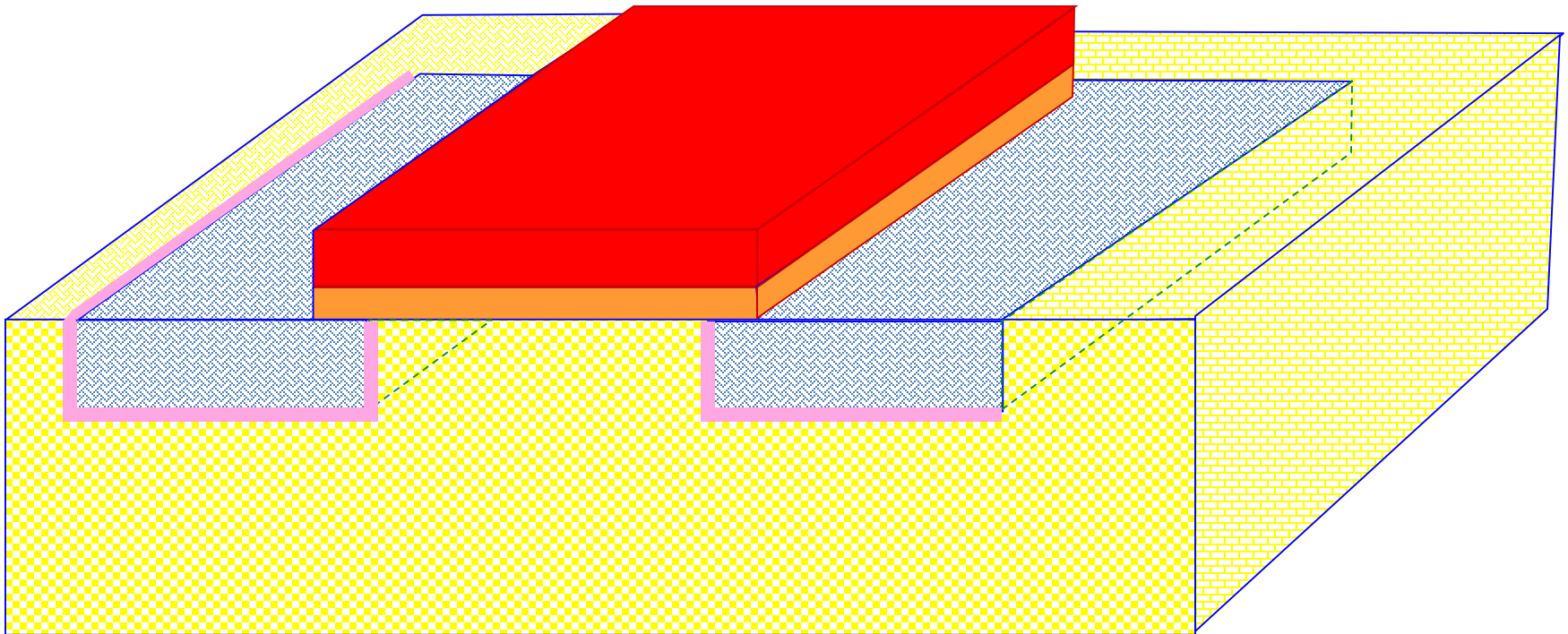


p-sub

n-Channel MOSFET

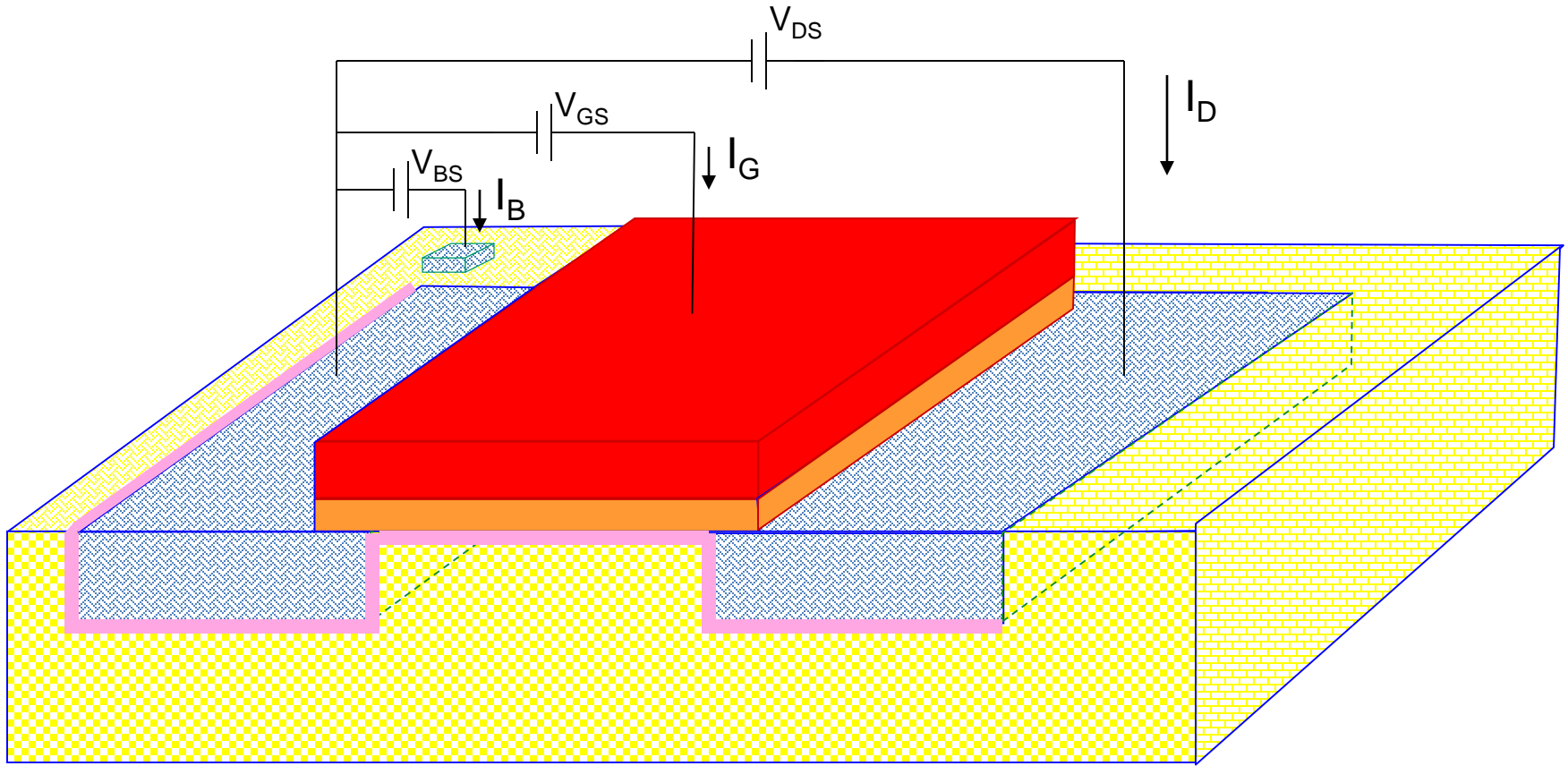


n-Channel MOSFET



- | | | | |
|--|---|---|------------|
|  | Poly |  | Gate oxide |
|  | n-active |  | p-sub |
|  | depletion region (electrically induced) | | |

n-Channel MOSFET Operation and Model



Apply small V_{GS}

(V_{DS} and V_{BS} assumed to be small)

Depletion region electrically induced in channel

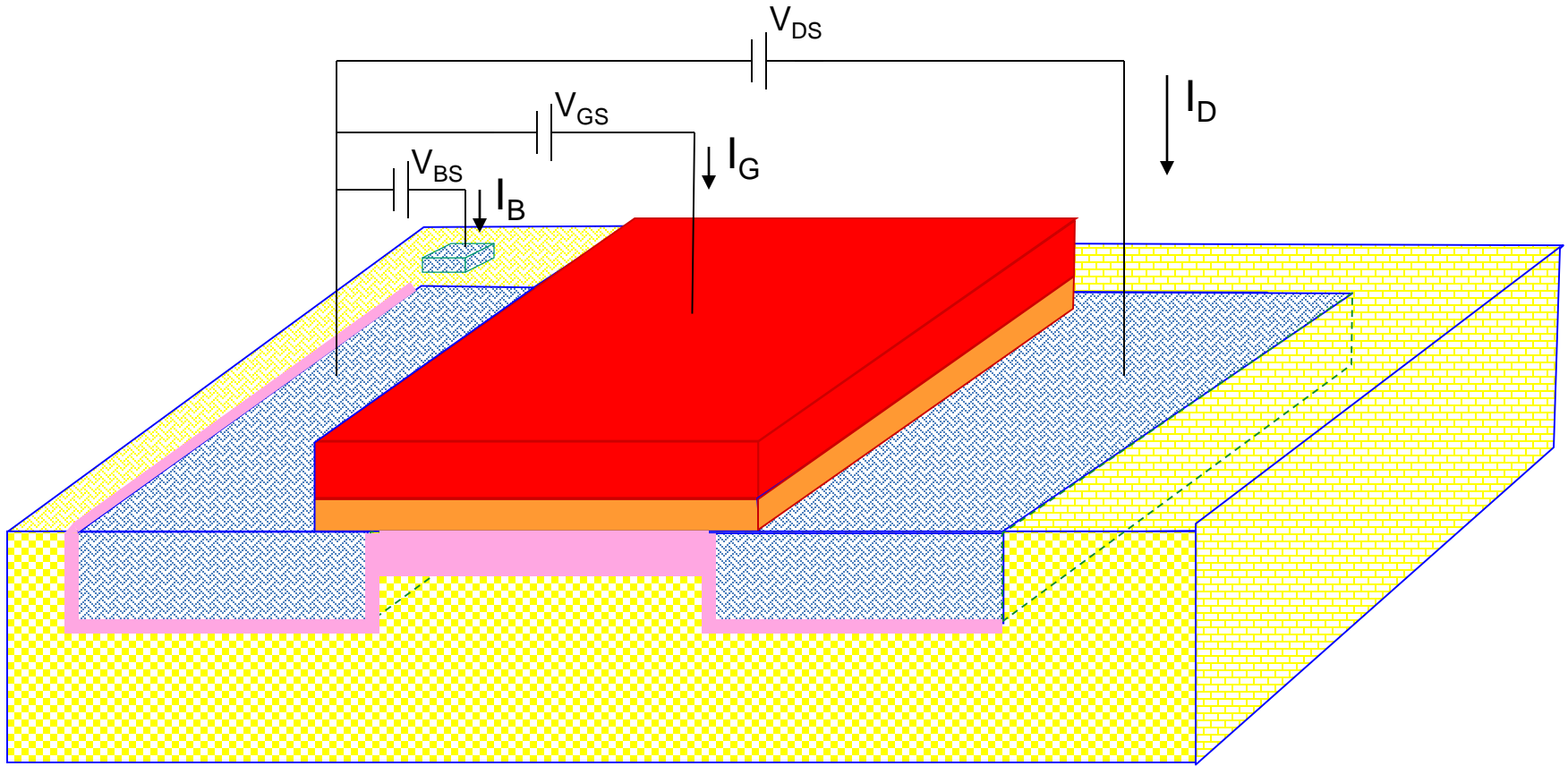
Termed “cutoff” region of operation

$$I_D=0$$

$$I_G=0$$

$$I_B=0$$

n-Channel MOSFET Operation and Model

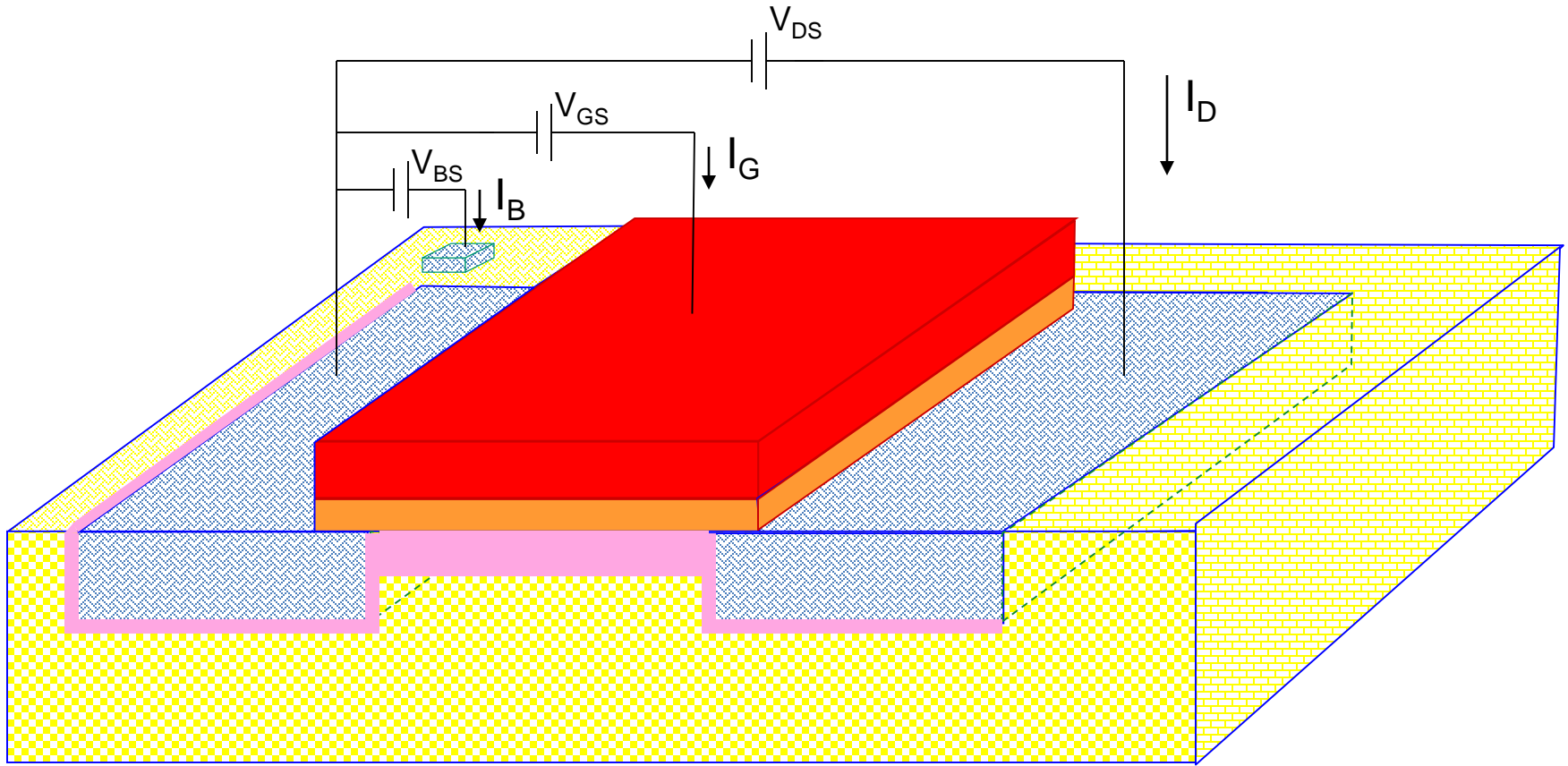


Increase V_{GS}
(V_{DS} and V_{BS} assumed to be small)

Depletion region in channel becomes larger

$$\begin{aligned} I_D &= 0 \\ I_G &= 0 \\ I_B &= 0 \end{aligned}$$

n-Channel MOSFET Operation and Model



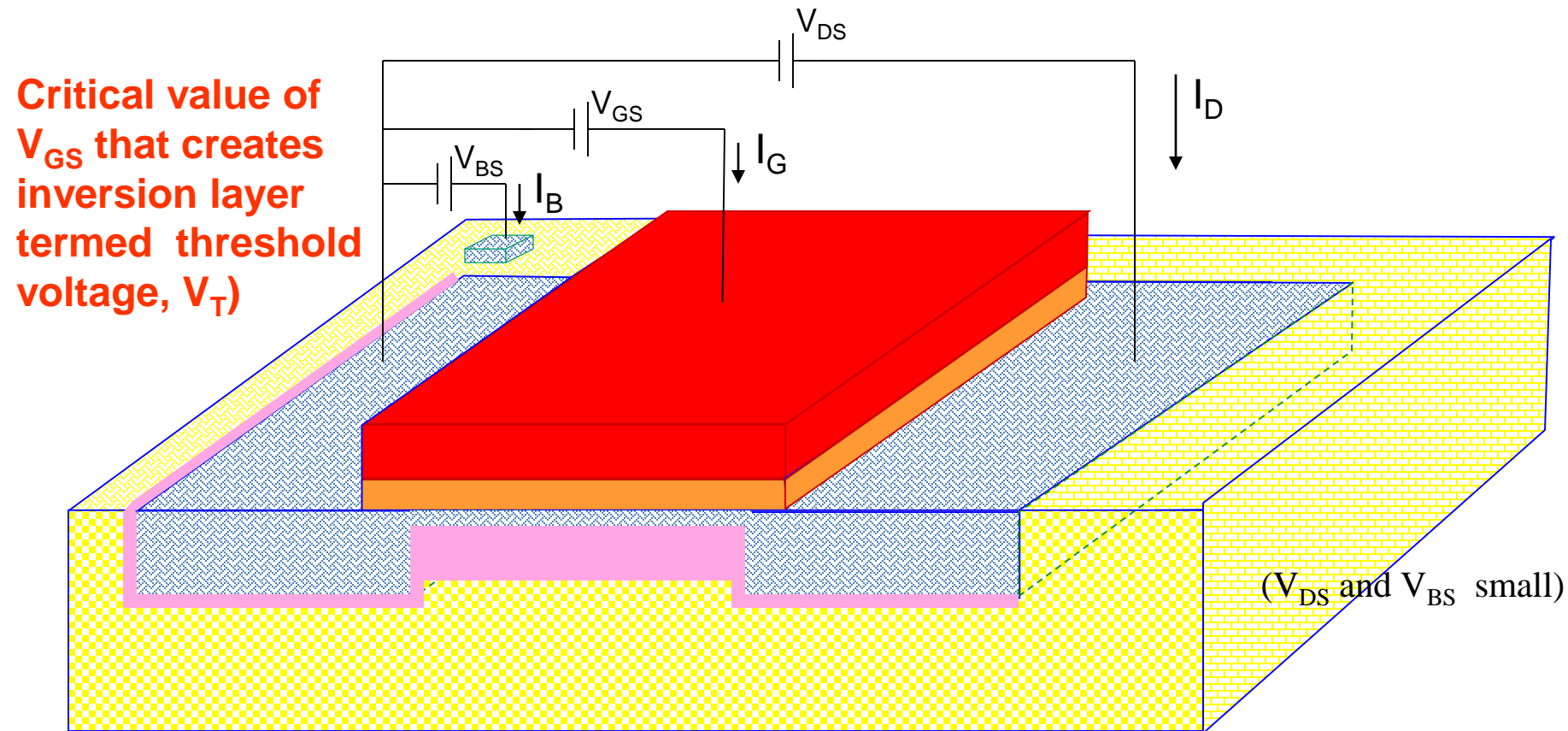
$$I_D=0$$

$$I_G=0$$

$$I_B=0$$

Model in Cutoff Region

n-Channel MOSFET Operation and Model



Increase V_{GS} more

Inversion layer forms in channel

Inversion layer will support current flow from D to S

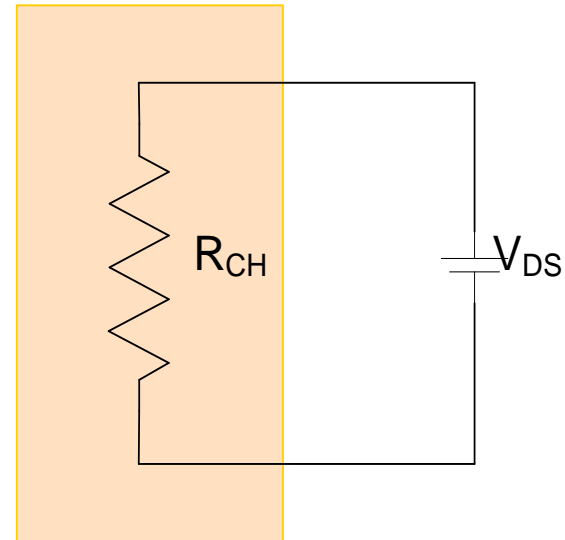
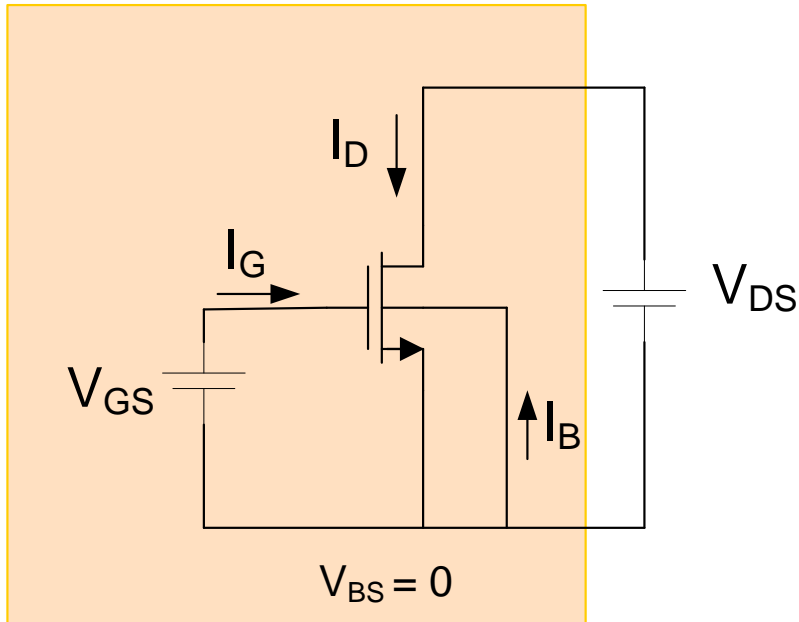
Channel behaves as thin-film resistor

$$I_D R_{CH} = V_{DS}$$

$$I_G = 0$$

$$I_B = 0$$

Triode Region of Operation



For V_{DS} small

$$R_{CH} = \frac{L}{W} \frac{1}{(V_{GS} - V_T) \mu C_{OX}}$$

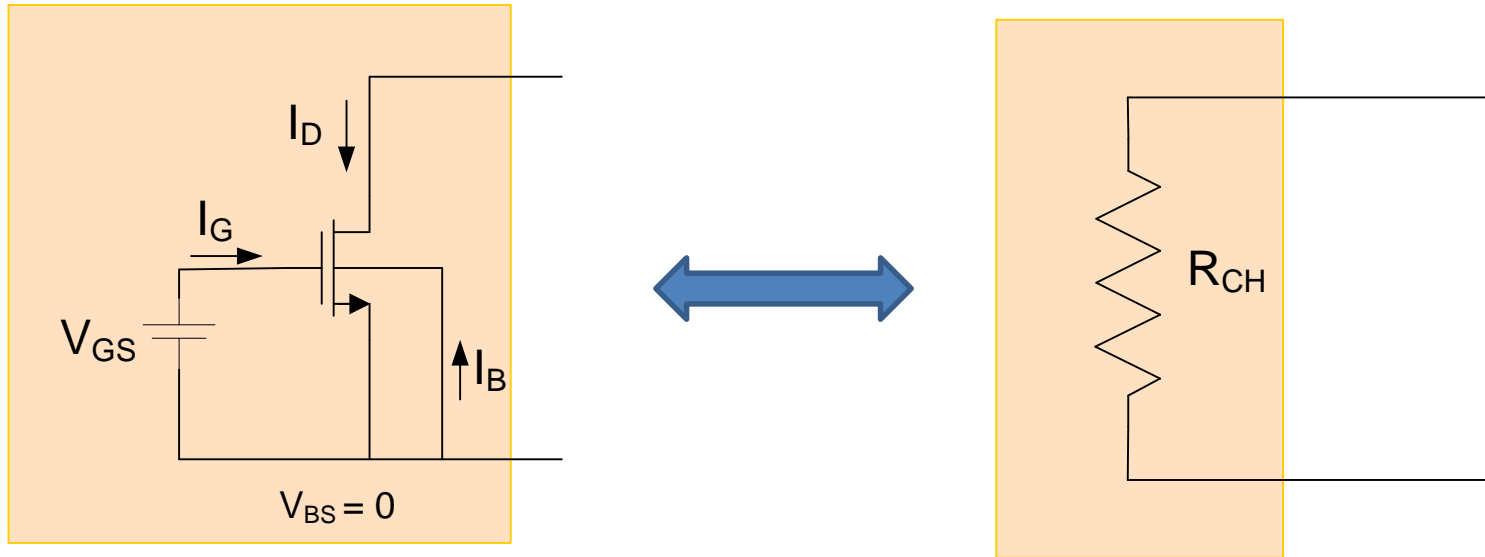
Behaves as a resistor between drain and source

$$I_D = \mu C_{OX} \frac{W}{L} (V_{GS} - V_T) V_{DS}$$

$$I_G = I_B = 0$$

Model in Deep Triode Region

Triode Region of Operation

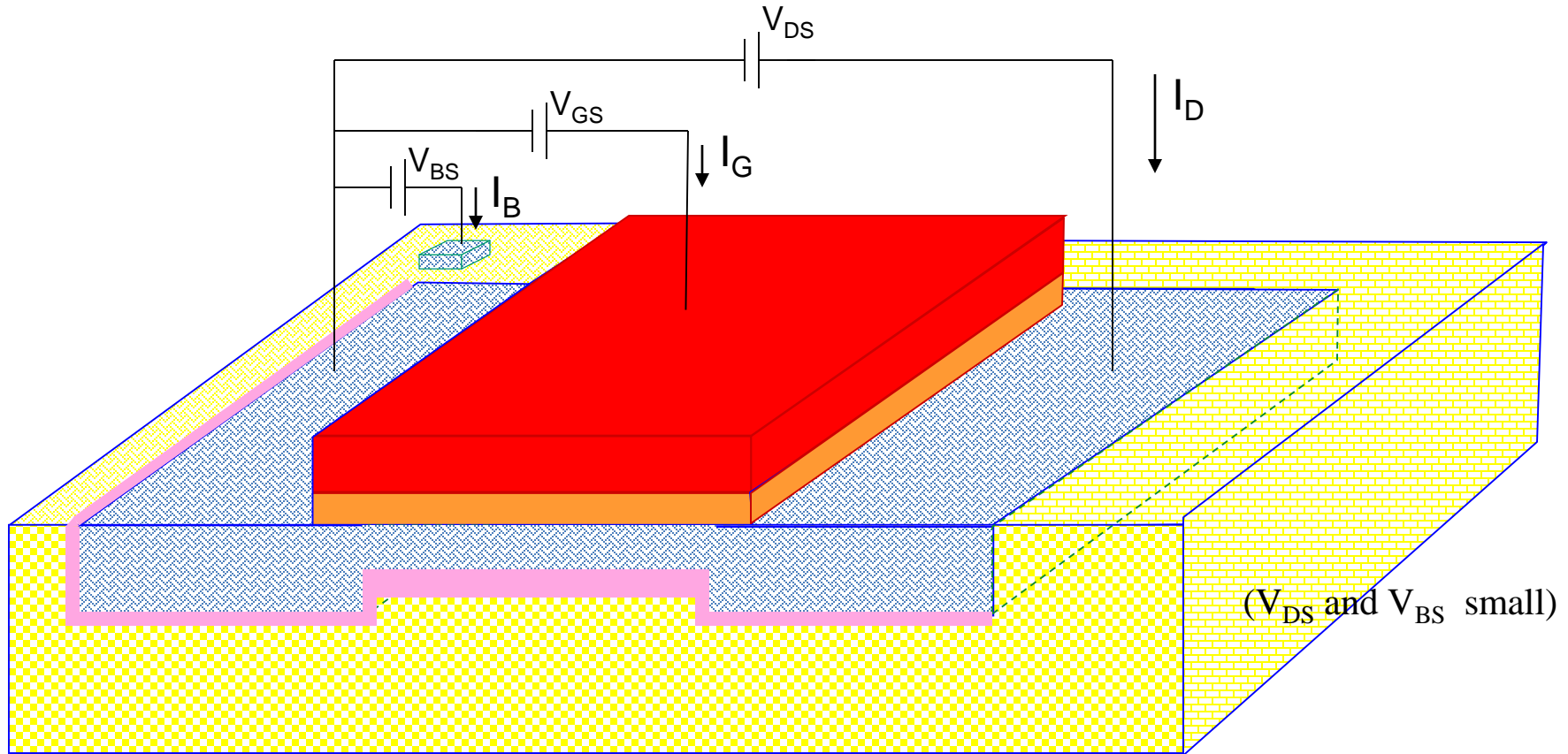


For V_{DS} small

$$R_{CH} = \frac{L}{W} \frac{1}{(V_{GS} - V_T) \mu C_{OX}}$$

Resistor is controlled by the voltage V_{GS}
Termed a "Voltage Controlled Resistor" (VCR)

n-Channel MOSFET Operation and Model



Increase V_{GS} more

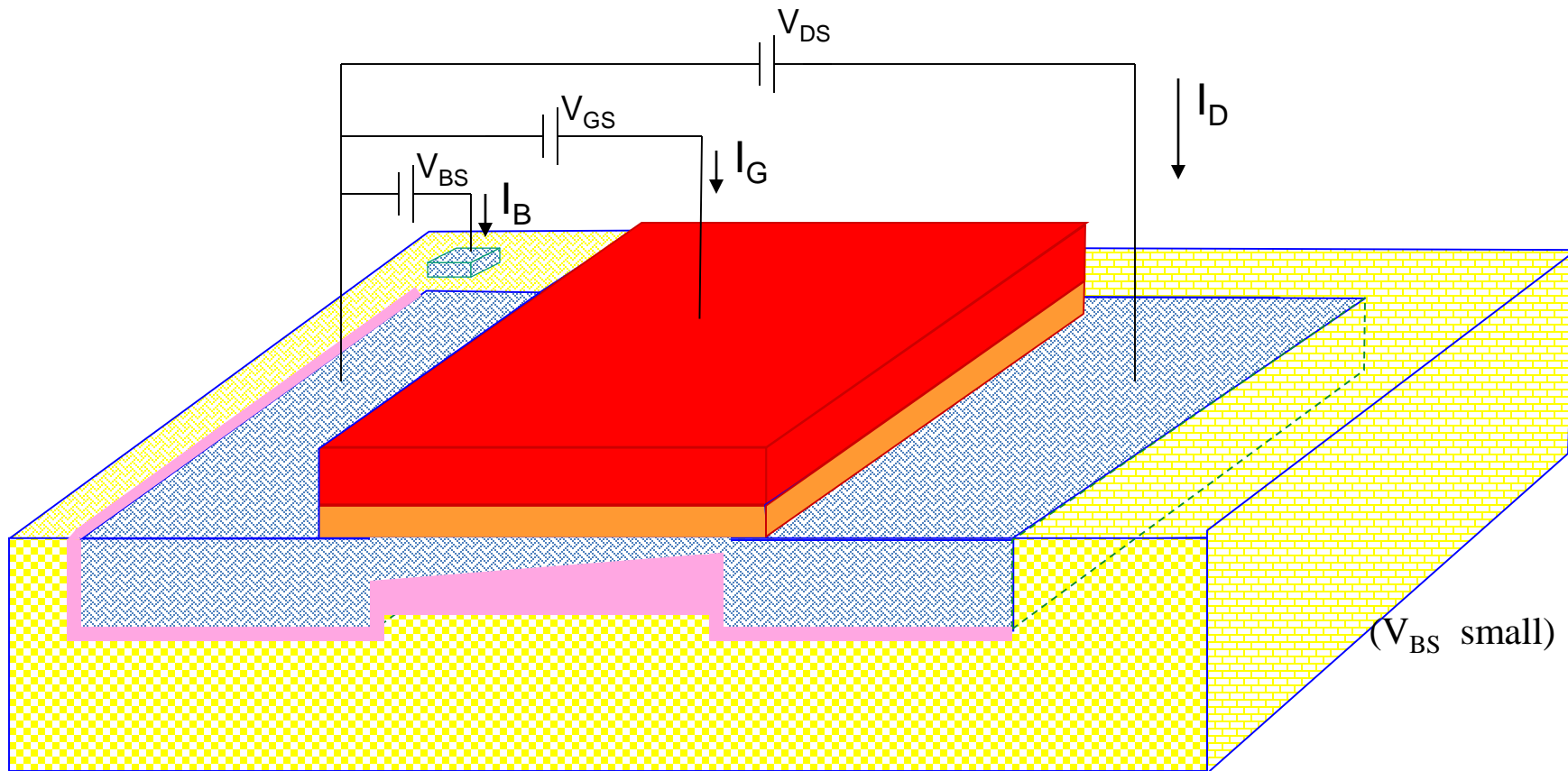
Inversion layer in channel thickens

R_{CH} will decrease

Termed “ohmic” or “triode” region of operation

$$\begin{aligned} I_D R_{CH} &= V_{DS} \\ I_G &= 0 \\ I_B &= 0 \end{aligned}$$

n-Channel MOSFET Operation and Model



Increase V_{DS}

Inversion layer thins near drain

I_D no longer linearly dependent upon V_{DS}

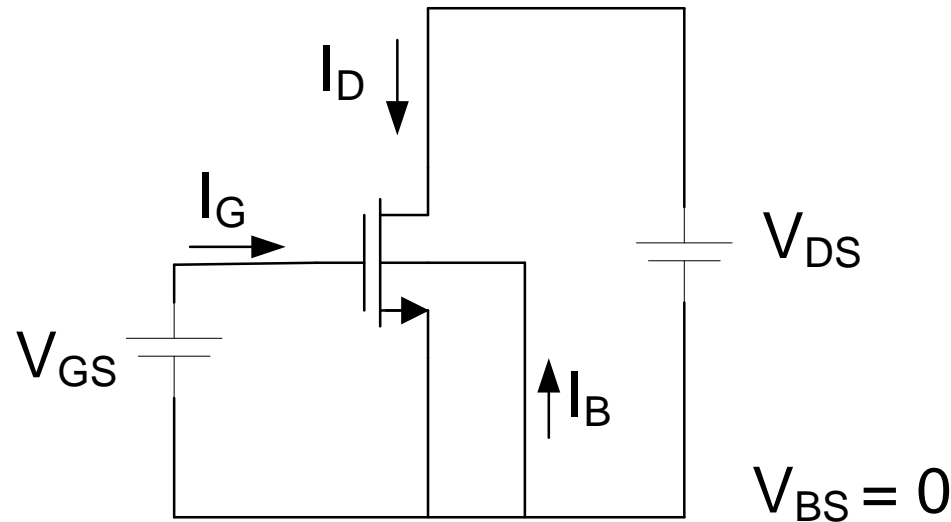
Still termed “ohmic” or “triode” region of operation

$$I_D = ?$$

$$I_G = 0$$

$$I_B = 0$$

Triode Region of Operation



For V_{DS} larger

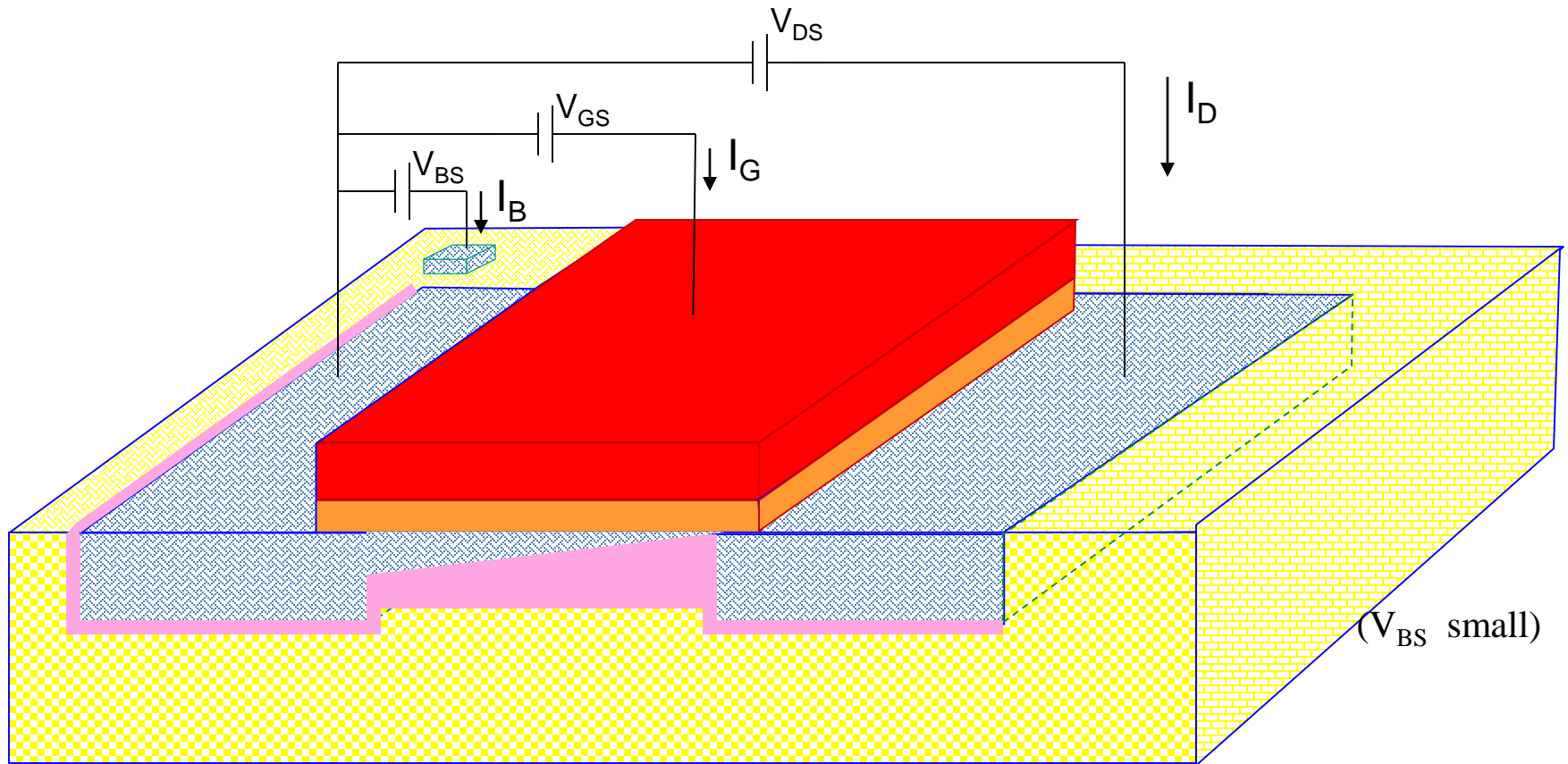
~~$$R_{CH} = \frac{L}{W} \frac{1}{(V_{GS} - V_T) \mu C_{OX}}$$~~

$$I_D = \mu C_{OX} \frac{W}{L} \left(V_{GS} - V_T - \frac{V_{DS}}{2} \right) V_{DS}$$

$$I_G = I_B = 0$$

Model in Triode Region

n-Channel MOSFET Operation and Model



Increase V_{DS} even more

Inversion layer disappears near drain

Termed "saturation" region of operation

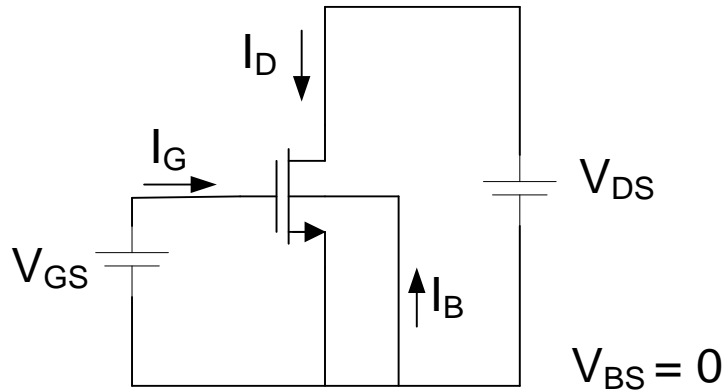
Saturation first occurs when $V_{DS} = V_{GS} - V_T$

$$I_D = ?$$

$$I_G = 0$$

$$I_B = 0$$

Saturation Region of Operation



$$I_D = \mu C_{ox} \frac{W}{L} \left(V_{GS} - V_T - \frac{V_{DS}}{2} \right) V_{DS}$$

or equivalently

$$I_D = \mu C_{ox} \frac{W}{L} \left(V_{GS} - V_T - \frac{V_{GS} - V_T}{2} \right) (V_{GS} - V_T)$$

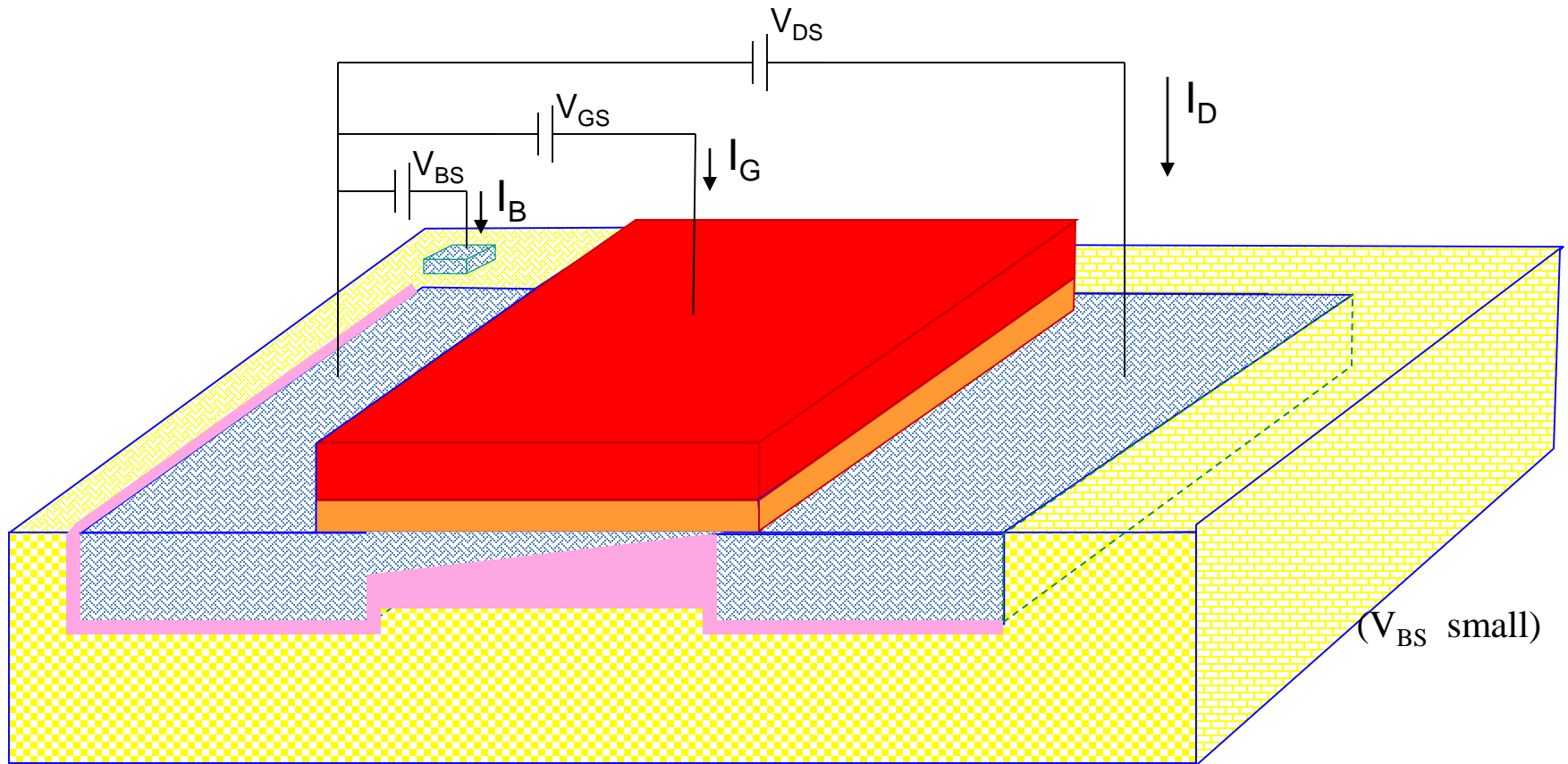
or equivalently

$$I_D = \frac{\mu C_{ox} W}{2L} (V_{GS} - V_T)^2$$

$$I_G = I_B = 0$$

For V_{DS} at onset of saturation

n-Channel MOSFET Operation and Model



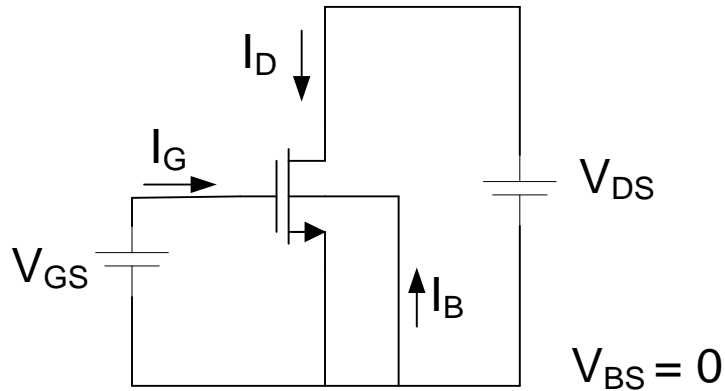
Increase V_{DS} even more (beyond $V_{GS} - V_T$)

Nothing much changes !!

Termed “saturation” region of operation

$$\begin{aligned} I_D &=? \\ I_G &=0 \\ I_B &=0 \end{aligned}$$

Saturation Region of Operation



For V_{DS} in Saturation

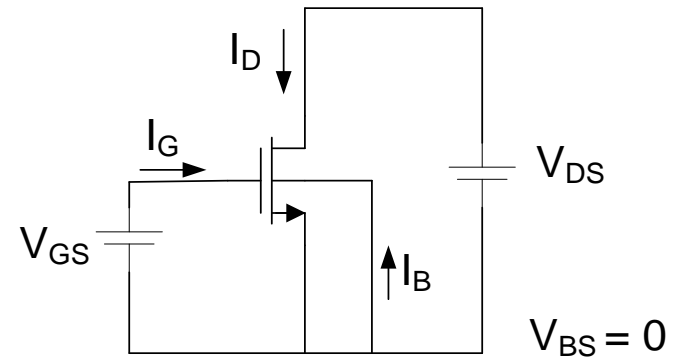
$$I_D = \frac{\mu C_{OX} W}{2L} (V_{GS} - V_T)^2$$

$$I_G = I_B = 0$$

Model in Saturation Region

Model Summary

n-channel MOSFET



$$I_D = \begin{cases} 0 \\ \mu C_{OX} \frac{W}{L} \left(V_{GS} - V_T - \frac{V_{DS}}{2} \right) V_{DS} \\ \mu C_{OX} \frac{W}{2L} (V_{GS} - V_T)^2 \end{cases}$$

$$V_{GS} \leq V_T$$

Cutoff

$$V_{GS} \geq V_T \quad V_{DS} < V_{GS} - V_T$$

Triode

$$V_{GS} \geq V_T \quad V_{DS} \geq V_{GS} - V_T$$

Saturation

$$I_G = I_B = 0$$

This is a piecewise model (not piecewise linear though)

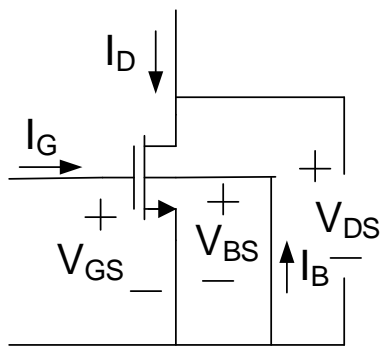
Note: This is the third model we have introduced for the MOSFET

(Deep triode special case of triode where V_{DS} is small

$$R_{CH} = \frac{L}{W} \frac{1}{(V_{GS} - V_T) \mu C_{OX}})$$

Model Summary

n-channel MOSFET



$$I_D = \begin{cases} 0 & V_{GS} \leq V_T \\ \mu C_{ox} \frac{W}{L} \left(V_{GS} - V_T - \frac{V_{DS}}{2} \right) V_{DS} & V_{GS} \geq V_T \quad V_{DS} < V_{GS} - V_T \\ \mu C_{ox} \frac{W}{2L} (V_{GS} - V_T)^2 & V_{GS} \geq V_T \quad V_{DS} \geq V_{GS} - V_T \end{cases}$$

$V_{BS} = 0$

$I_G = I_B = 0$

Observations about this model (developed for $V_{BS}=0$):

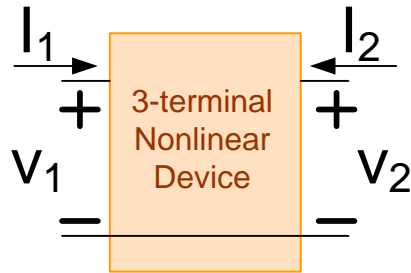
$$I_D = f_1(V_{GS}, V_{DS})$$

$$I_G = f_2(V_{GS}, V_{DS})$$

$$I_B = f_3(V_{GS}, V_{DS})$$

This is a nonlinear model characterized by the functions f_1 , f_2 , and f_3 where we have assumed that the port voltages V_{GS} and V_{DS} are the independent variables and the drain currents are the dependent variables

General Nonlinear Models

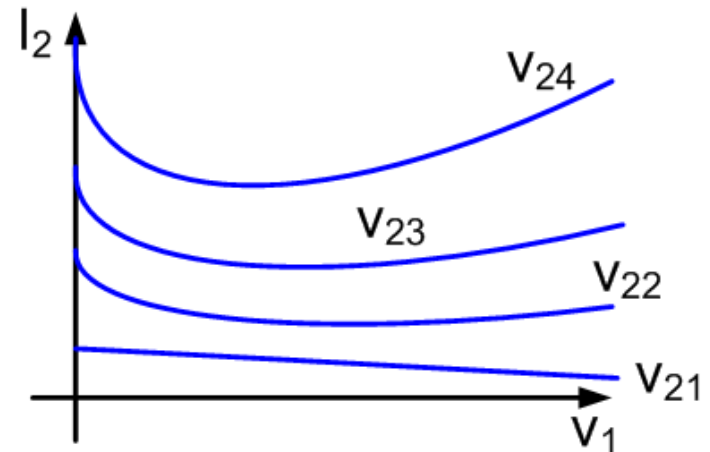
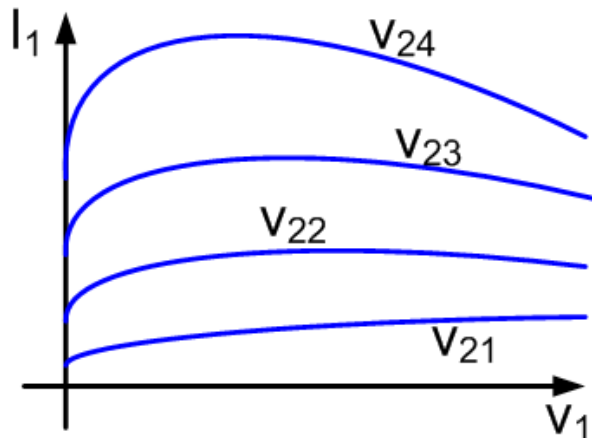


$$I_1 = f_1(V_1, V_2)$$

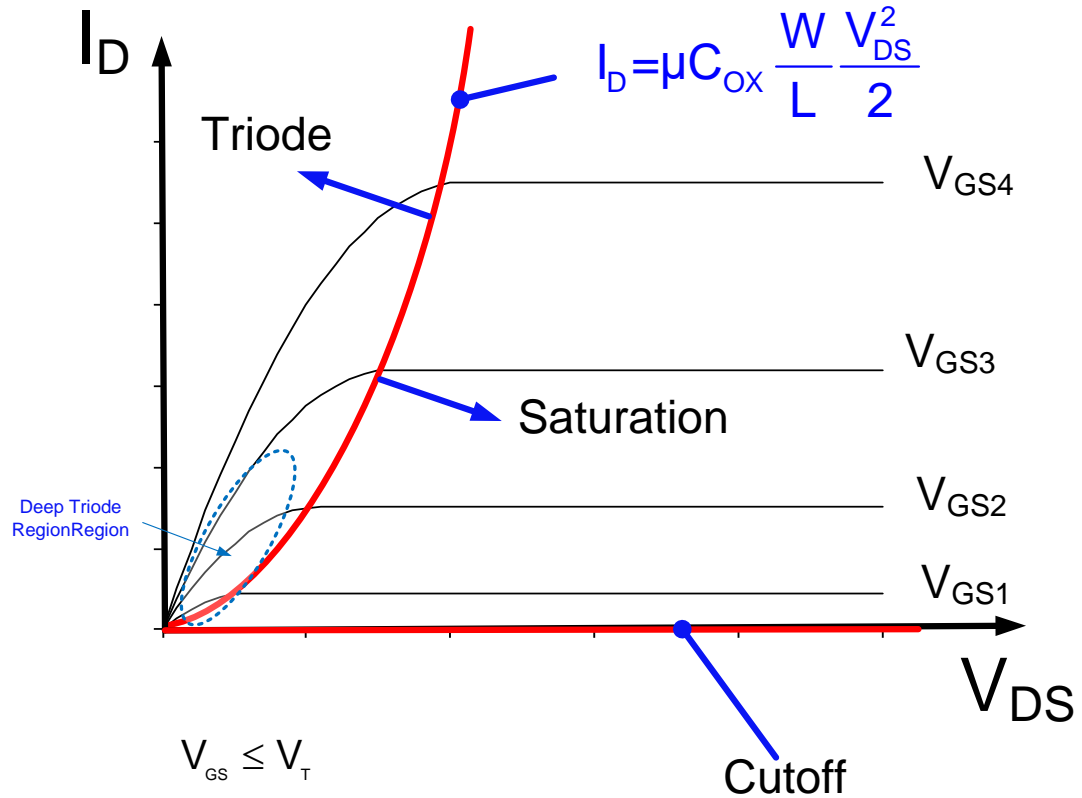
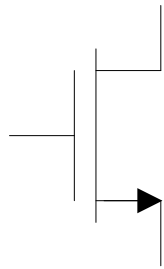
$$I_2 = f_2(V_1, V_2)$$

I_1 and I_2 are 3-dimensional relationships which are often difficult to visualize

Two-dimensional representation of 3-dimensional relationships



Graphical Representation of MOS Model



$$I_D = \begin{cases} 0 & V_{GS} \leq V_T \\ \mu C_{ox} \frac{W}{L} \left(V_{GS} - V_T - \frac{V_{DS}}{2} \right) V_{DS} & V_{GS} \geq V_T, V_{DS} < V_{GS} - V_T \\ \mu C_{ox} \frac{W}{2L} (V_{GS} - V_T)^2 & V_{GS} \geq V_T, V_{DS} \geq V_{GS} - V_T \end{cases}$$

$$I_G = I_B = 0$$

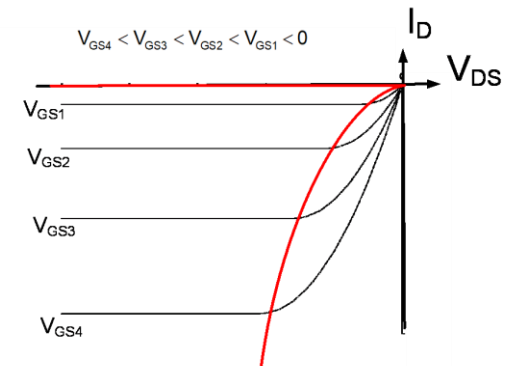
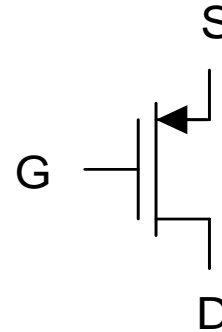
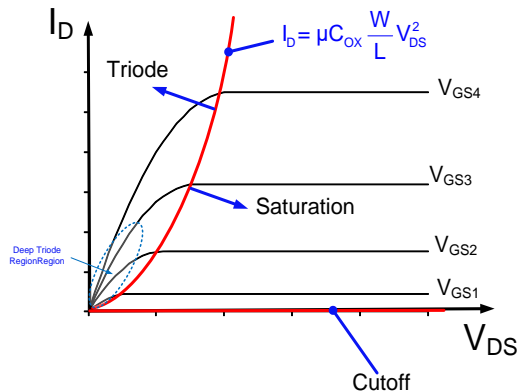
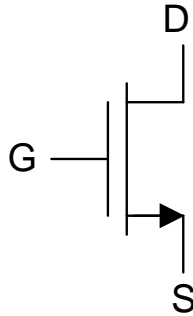
$$V_{GS} \leq V_T$$

$$V_{GS} \geq V_T, V_{DS} < V_{GS} - V_T$$

$$V_{GS} \geq V_T, V_{DS} \geq V_{GS} - V_T$$

Parabola separated triode and saturation regions and corresponds to $V_{DS} = V_{GS} - V_T$

PMOS and NMOS Models



- Functional form identical, sign changes and parameter values different
- Will give details about p-channel model later

End of Lecture 16